

Interlaminar Crack Propagation in 3D-Printed Plastics Using High Speed DIC

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USU is ~1.5 hours North of SLC

Presentation-Only Abstracts due July 22

(Track 11: Mechanics of Solids, Structures, and Fluids)

Over 40 topic areas, including:

11-13: Quantitative Visualization of Fracture and Failure

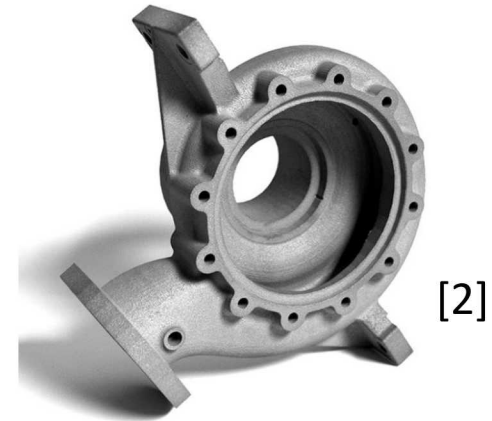
11-15: Mechanical Characterization in Extreme Environments

11-18: In-Situ Techniques in Experimental Mechanics

...plus many others!

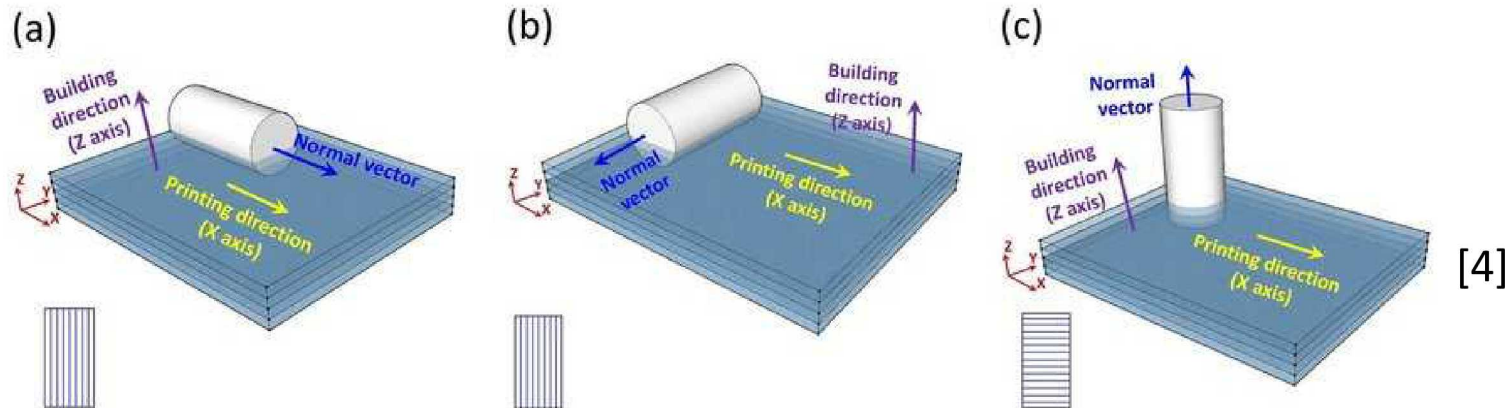
3D Printing

- 3D Printing is currently used to produce structural parts
- Need for characterization of properties for 3D printed materials [1]
- Little research on how 3D printed material fails under high loading rate



Print Orientation

- Print orientation affects part strength
- Unknown how laminar structure effects failure energy of 3D printed parts [3]

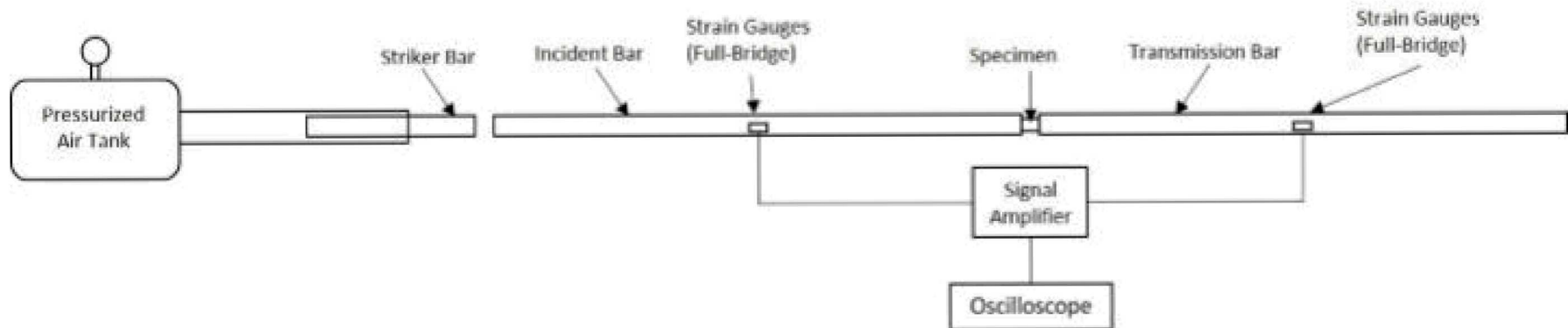


[1] 2fprototypes., www.2fprototypes.net/prototype/customized-on-demand-cnc-machining-service.html

[2] D. L. Bourell and J. J. Beaman, "A Brief History of Additive Manufacturing and the 2009 Roadmap for Additive Manufacturing: Looking Back and Looking Ahead," p. 7, 2009.

[3] K. M. Ashtankar, et al. "RAPID PROTOTYPING STYRENE (ABS) PARTS. Unknown how laminar structure effects failure energy of 3D printed parts

[4] Li Wantg, 2017, "The mechanical and photoelastic properties of 3D printable stress-visualized materials", Scientific Reports.



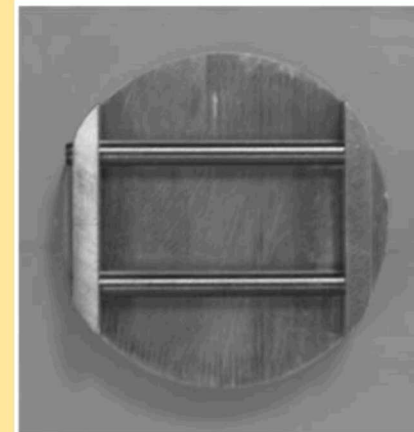
Method for Kolsky Bar

- Stress wave travels hits the specimen
- Wave travels through the transmission bar
- Reflected wave travels back through the incident bar
- Strain gauges detect stress waves
- Data used to calculate loading rate, and failure energy

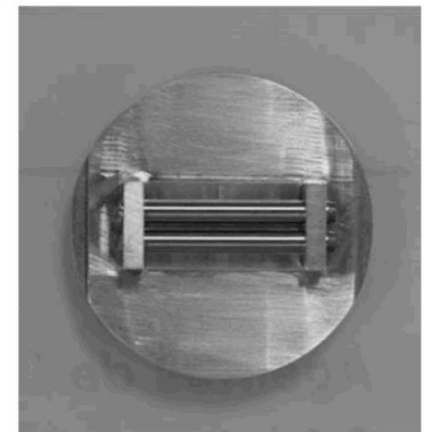
[5] Chul Jin Syn and W. W. Chen, "Surface Morphology Effects on High-Rate Fracture of an Aluminum/Epoxy Interface," *Journal of Composite Materials*, vol. 42, no. 16, pp. 1639–1658, Aug. 2008.

Alternative Specimen

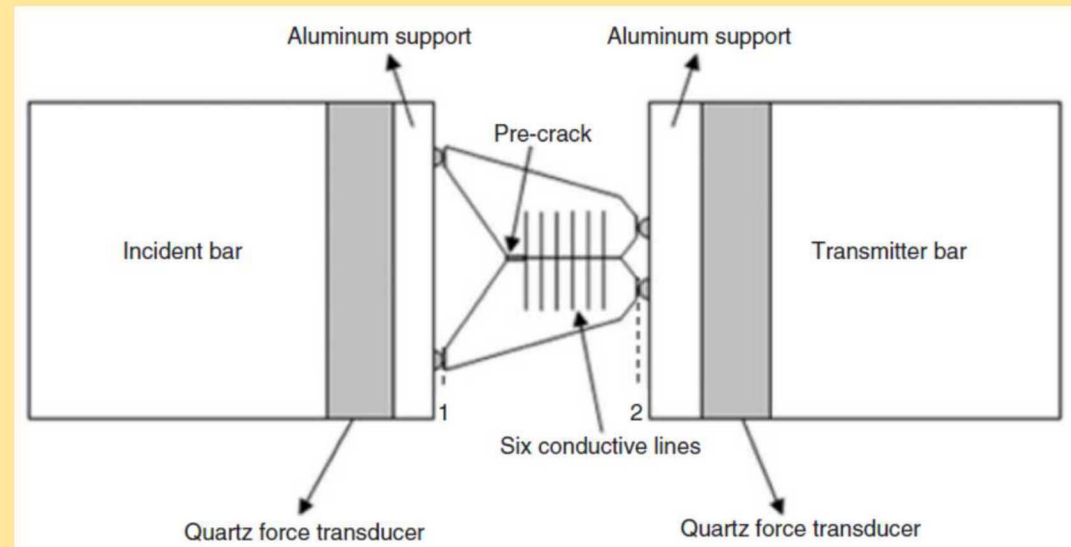
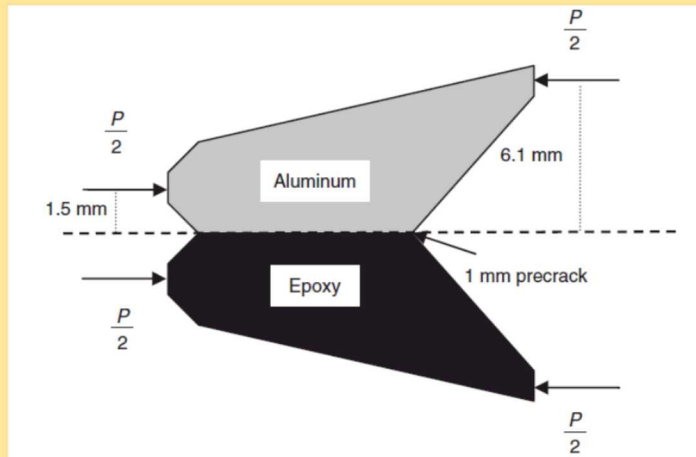
- Used conductive paint to determine when crack had broken circuit path



Incident bar side

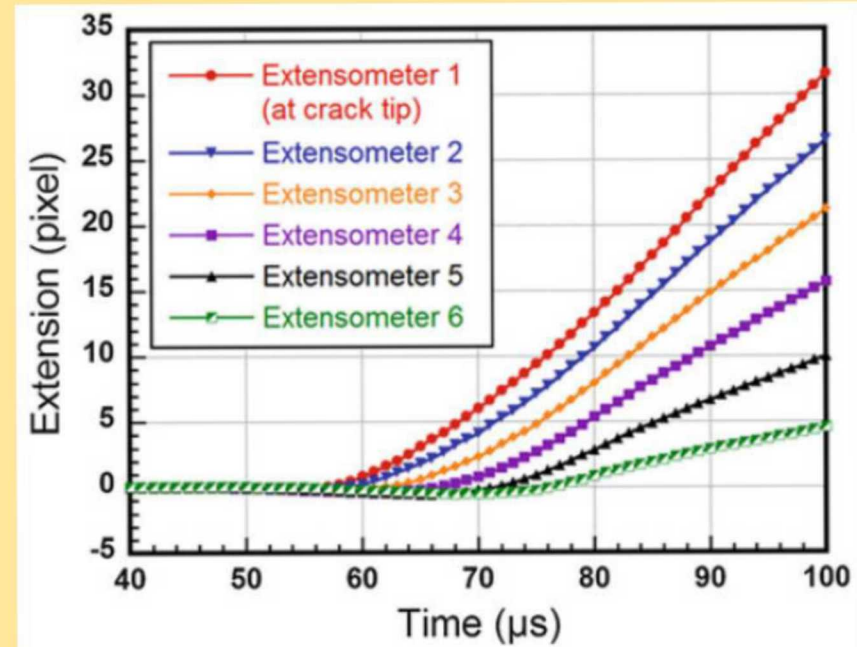
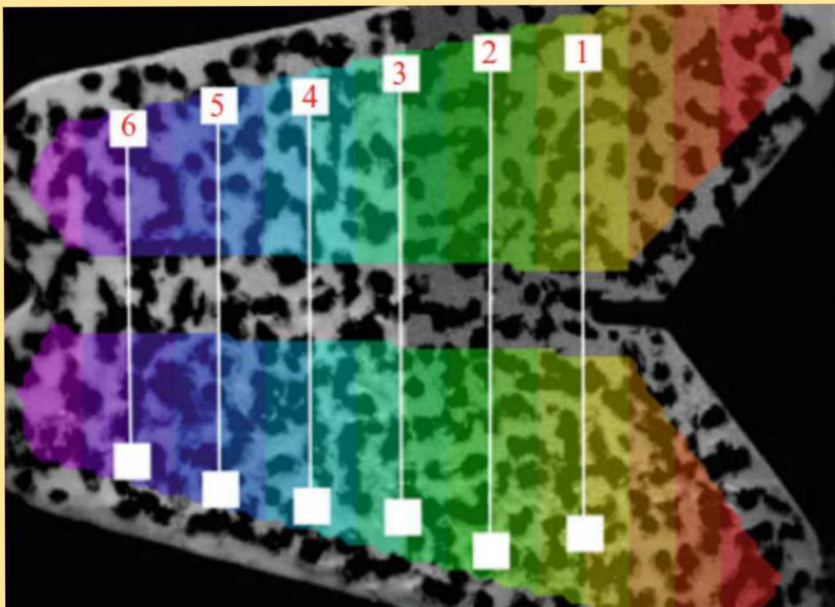


Transmitter bar side



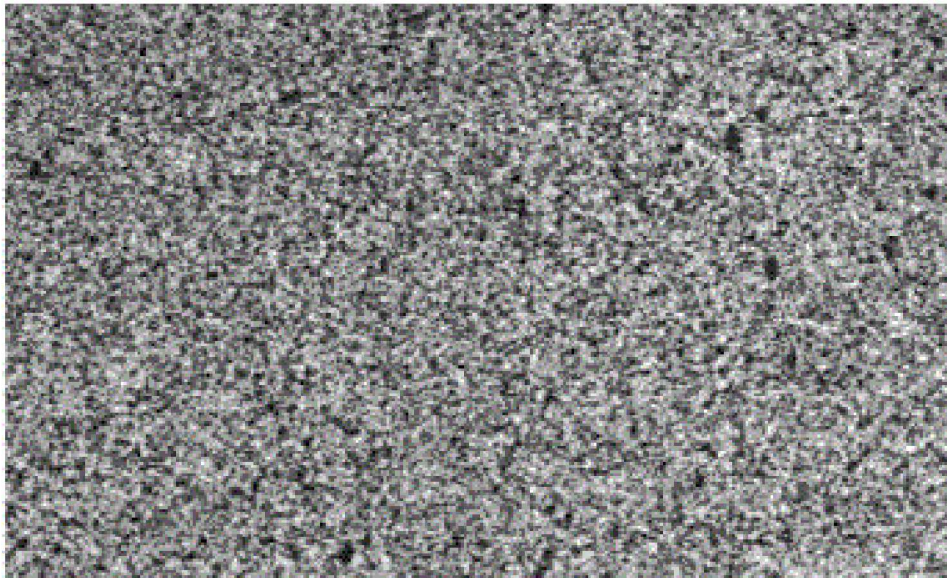


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- Technical drawing of a mechanical part with dimensions in mm. The part is a symmetrical, elongated shape with a central rectangular cutout. The dimensions are as follows:
- Overall width: 7.42
 - Overall height: 6.42
 - Radius of the top-right corner: $R0.94 \times 4$
 - Radius of the bottom-right corner: $R0.94 \times 4$
 - Width of the central cutout: 0.80
 - Height of the central cutout: 0.36
 - Distance from the left edge to the start of the central cutout: 5.55
 - Distance from the right edge to the end of the central cutout: 4.57
 - Distance from the top edge to the start of the central cutout: 4.55
 - Distance from the bottom edge to the end of the central cutout: 2.71



Digital image correlation(DIC) is advantageous because:

- Time scale is determined by the Camera
- Lens allows for a smaller scale length measurements
- Other measurement techniques are difficult at high speeds
- Non-contact
- Measures full field displacements of pixel subsets (full field strains)





Kolsky bar with speckled butterfly specimen in between incident and reflected bar

Shimadzu HPV-X2 high-speed camera with Tonika macro 100mm f2.8 lens positioned 10 in. from the specimen

Full bridge Vishay strain gauges wired to an oscilloscope, amplifier, and camera



Kolsky bar at Owen Kingstedt's lab University of Utah

Butterfly specimen tested in Kolsky bar
X, Y, and Z orientations

Material is 3D printed abs plastic

Loading rates determined from strain
gauge data.

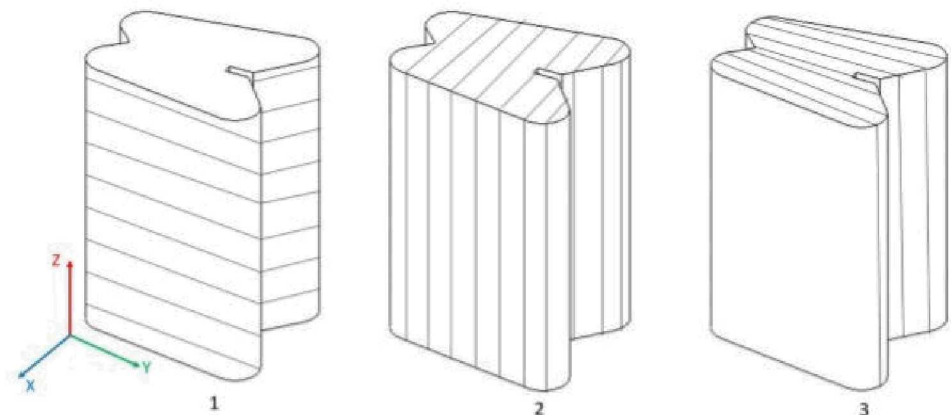
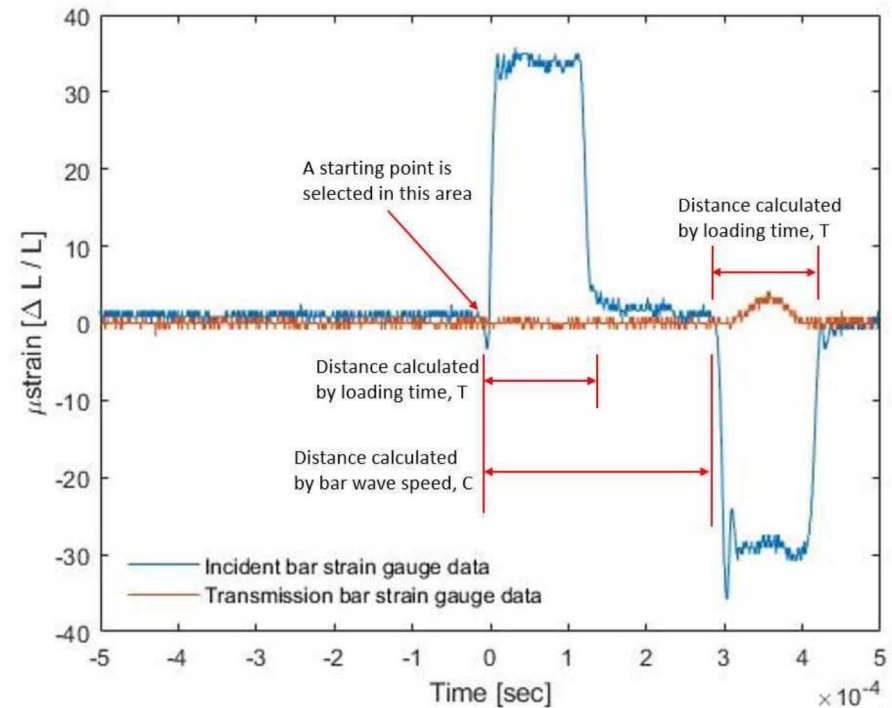
Theoretical wave speed is used to plot
strain vs. time data

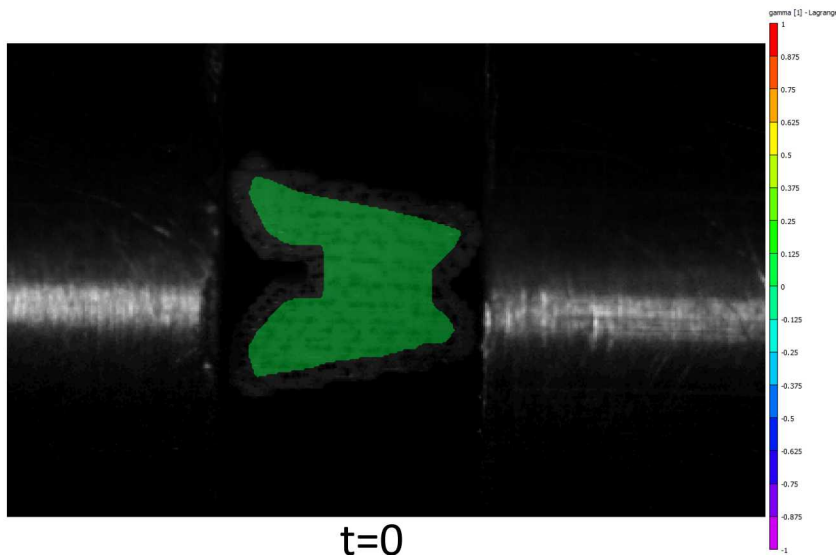
Specimen is painted with a speckle
pattern and processed through DIC

Loading rate is calculated using:

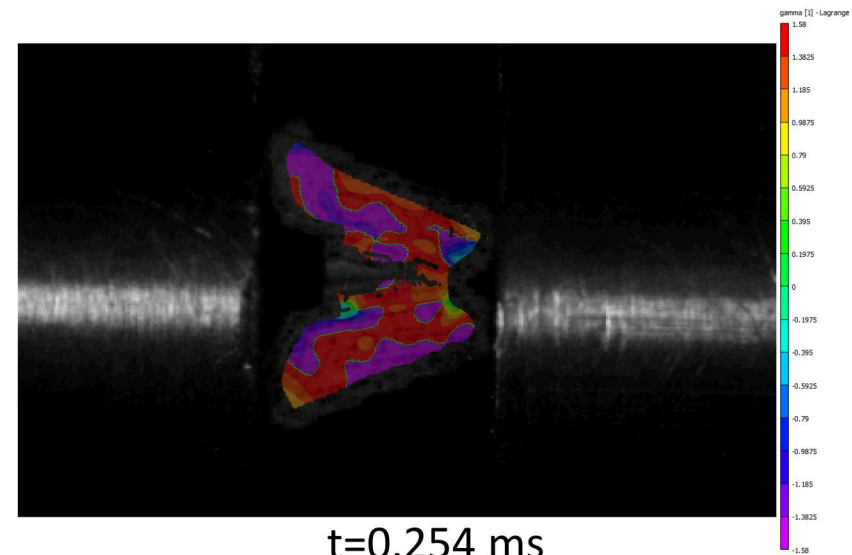
$$P_I = E_b A_b (\epsilon_I + \epsilon_R) \quad (1)$$

$$P_{II} = E_b A_b \epsilon_T \quad (2)$$





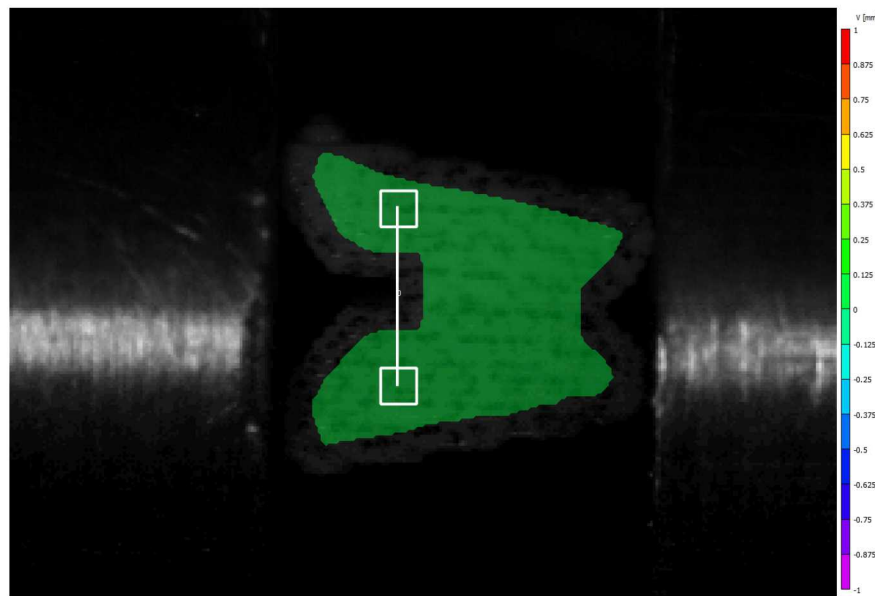
$t=0$



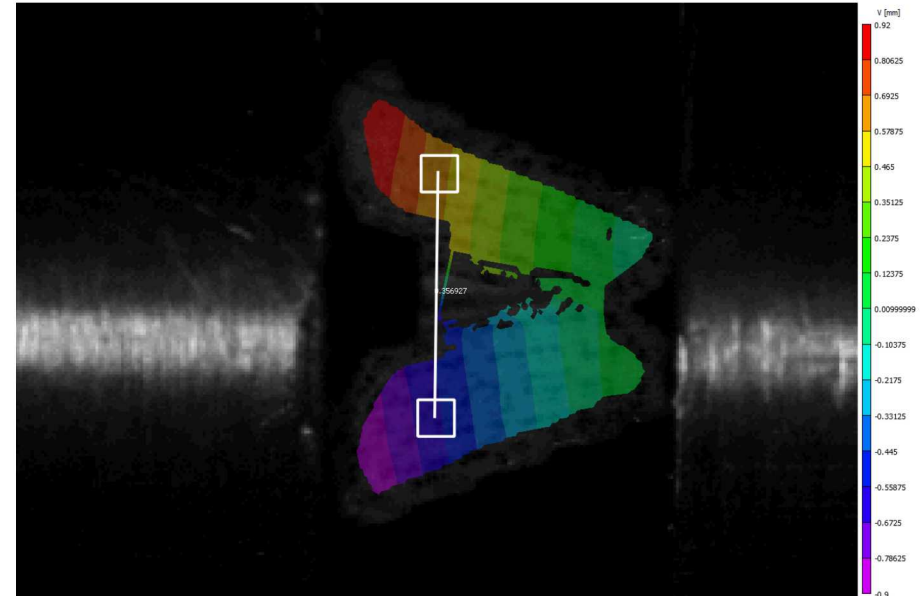
$t=0.254$ ms

- Subset: 17 pixels – best subset based off speckle size
- Step size: 1 pixel – smaller subset to get more detail around crack
- Exposure Time and Fps chosen based off the late crack formation in the specimen
- Approximately 127 frames per test

Orientation	Psi	Exposure Time (s)	Frames per sec
X	8	1500	500,000
Y	8	1500	500,000
Z	8	1500	500,000



t=0



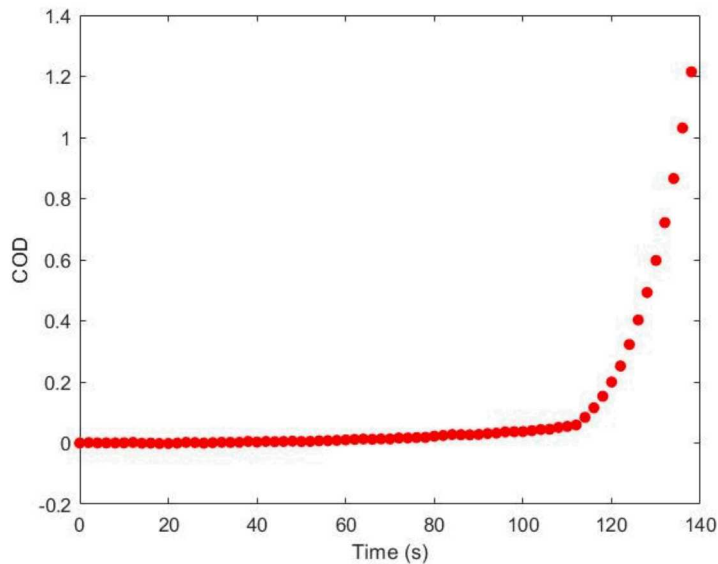
t=0.254 ms

Displacement data from VIC-2D is used to create a digital extensometer to determine COD

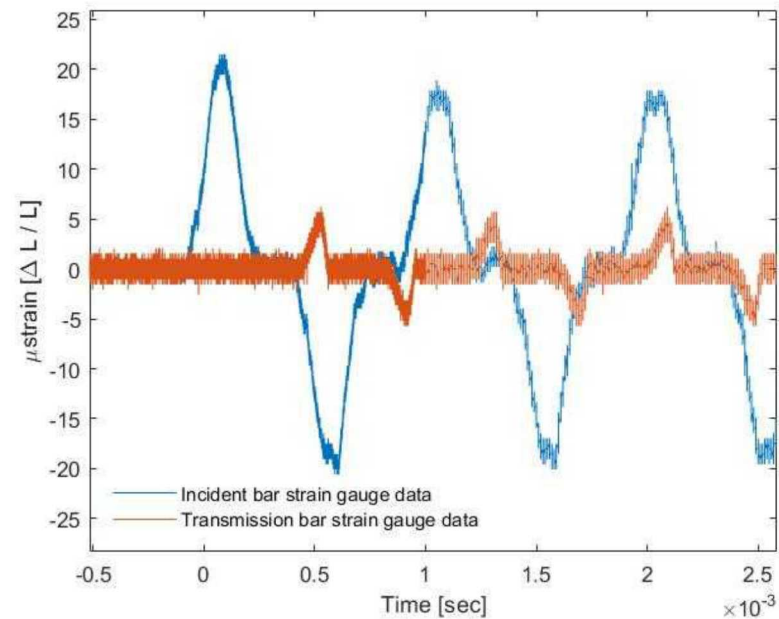
Time zero is determined visually with images and then aligned with stress wave data

The crack path is tracked in each image. By measuring the displacement of the movement above and below the crack plane COD vs. time can be determined

Failure energy is calculated using COD and loading rate. Failure energy for each orientation will be compared



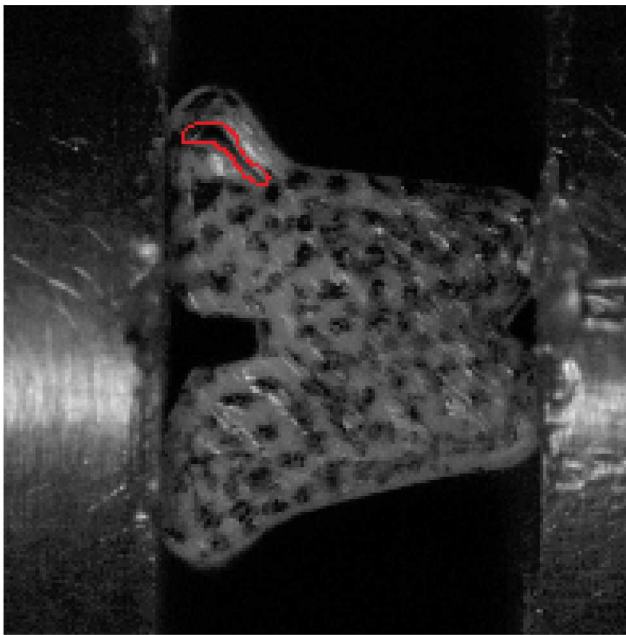
Graph of COD from initial loading to fracture



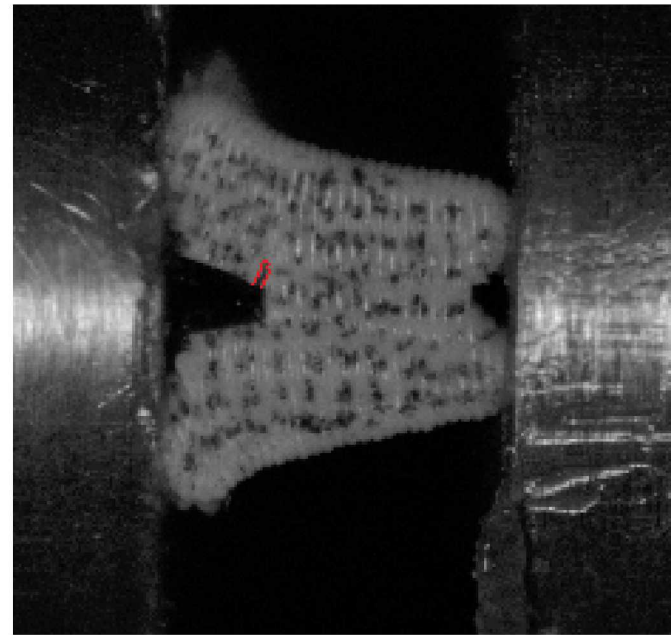
- COD calculated by tracking two points above and below the pre-crack tip
- Failure Energy calculated using force vs. time data and COD

$$FE = \int_{x_0}^{x_{critical}} P(x) dx$$

- Z and Y orientations either didn't crack at 8 Psi or had the wrong crack path
- Possibly due to machining method – cut with 0.5 mm saw



Z Orientation



Y Orientation

Failure Energy:

- $FE = \int_{t_0}^{t_{critical}} P(x)dx$
- Δx and F not in the same direction
- Wasn't apparent from Whittie paper
- More research needed to use this method

Next Steps:

- Test Y and Z Orientation
 - Find better machining method
 - Increase PSI
 - Possible interference from reflected wave
- Kolsky and DIC will still be used to measure Y and Z orientations



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